

**REMARKS**

The final Office Action mailed on May 5, 2005, has been received and its contents carefully considered.

Claims 3, 5-8, 10, 12-16 and 19 are pending in this application. In this Amendment, claims 5 and 7 are canceled without prejudice or waiver of the subject matter recited therein, claim 8 is amended and new claims 21-27 are added. As a result, claims 3, 8 and 21 are now the independent claims in this application.

The Applicants note with appreciation the Examiner's indication in the current Action that claims 3, 6, 8, 10, 12-16 and 19 are allowed.

In the Action, claims 5 and 7 are rejected under 35 USC §103(a) as being obvious over *Tzu* (U.S. Patent No. 6,201,302) in view of *Kim et al.* (KR 2002042958), further in view of *Rolda, Jr. et al.* (U.S. Pat. Publ. No. 2002/0030261) and further in view of a newly cited reference, *Fukutomi et al.* (U.S. Patent No. 6,268,648). It is respectfully submitted that the rejection is moot in view of the cancellation herein of claims 5 and 7.

Claim 8 is amended herein by changing the phrase "adhesive sheet small hole", in the last line of the claim, to read "small hole in the adhesive sheet." The change is made solely for consistency of style, and it does not, the Applicants believe, affect the allowability of the claim.

New claim 21 recites substantially the same limitations as claim 8, but is directed to the embodiment of the invention illustrated in Figure 4 of the application, which has "an adhesive sheet formed of sheet-shaped adhesive material at the first surface of the interposer substrate so as to cover the through-hole, the adhesive sheet being larger than the second chip size and further having a hole smaller than the second chip size in width and larger than the second chip size in length" (emphasis added). The Applicants respectfully submit that the applied prior art references fail to teach or suggest the new limitations recited in claim 21.

New dependant claims 22-27 recite additional limitations of the invention regarding the relative sizes of the first integrated semiconductor chip and the second integrated semiconductor chip, as disclosed in the application. The Applicants

believe that these new claims are allowable for at least the reason that they depend from independent claims 3, 8 and 21.

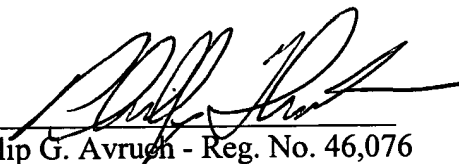
It is respectfully submitted that this Amendment places the application in condition for allowance. Notice of allowance, with claims 3, 6, 8, 10, 12-16, 19 and 21-27, is earnestly solicited.

Should the Examiner believe that a conference would help to expedite the prosecution of this application, the Examiner is encouraged to contact the undersigned counsel to arrange for such an interview.

Respectfully submitted,

July 28, 2005

Date

  
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